

TS-WDM-0220A

1.25Gbps SFP Bi-Directional Transceiver, 20km Reach 1550nm TX / 1310nm RX

Features

- Dual data-rate of 1.25Gbps/1.063Gbps operation
- 1550nm DFB laser and PIN photodetector for 20km transmission
- Compliant with SFP MSA and SFF-8472 with simplex LC or SC receptacle
- Digital Diagnostic Monitoring:
 Internal Calibration or External Calibration
- · Compatible with SONET OC-24-LR-1
- Compatible with RoHS
- +3.3V single power supply
- Operating case temperature range of 0°C to +70°C (Commercial) or -40°C to +85°C (Industrial)



Applications

- · Gigabit Ethernet
- Fiber Channel
- · Switch to Switch interface
- · Switched backplane applications
- Router/Server interface
- · Other optical transmission systems

Description

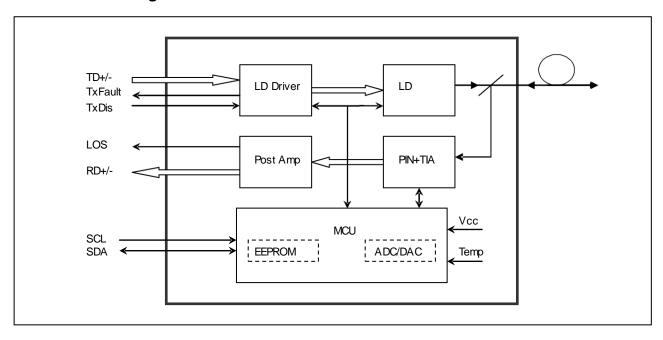
The SFP-BIDI transceivers are high performance, cost effective modules supporting dual data-rate of 1.25Gbps/1.063Gbps and 20km transmission distance with SMF.

The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.



Module Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

Recommended Operating Conditions

Parameter		Symbol	Min	Typical	Max	Unit	
On another Ocean Terror and an		Commercial	To	0		+70	°C
Operating Case Temperature	Industrial	Tc ·	-40		+85	°C	
Pow er Supply Voltage		Vcc	3.13	3.3	3.47	V	
Pow er Supply Current		lcc			300	mA	
	Gigabit Ethern	et			1.25		Chan
Data Rate	Fiber Channel				1.063		Gbps



Optical and Electrical Characteristics

Parai	neter	Symbol	Min	Typical	Max	Unit	Notes
		Transmitte	er				
Centre Wavelength		λς	1530	1550	1570	nm	
Spectral Width (-20dB)		Δλ			1	nm	
Side Mode Suppression R	atio	SMSR	30			dB	
Average Output Power		Pout	-9		-3	dBm	1
Extinction Ratio		ER	9		13	dB	
Optical Rise/Fall Time (20	%~80%)	t _r /t _f			0.26	ns	
Data Input Swing Different	ial	V _{IN}	400		1800	mV	2
Input Differential Impedance	е	Z _{IN}	90	100	110	Ω	
TV Distable	Disable		2.0		Vcc	V	
TX Disable	Enable		0		0.8	V	
TX Fault	Fault		2.0		Vcc	V	
	Normal		0		0.8	V	
		Receive	•				
Centre Wavelength		λς	1260		1360	nm	
Receiver Sensitivity					-22	dBm	3
Receiver Overload			-3			dBm	3
LOS De-Assert		LOS _D			-24	dBm	
LOS Assert		LOSA	-35			dBm	
LOS Hysteresis			1		4	dB	
Data Output Swing Differential		Vout	400		1800	mV	4
1.00		High	2.0		Vcc	V	
LUS	LOS				0.8	V	

Notes

- 1. The optical pow er is launched into SMF.
- 2. PECL input, internally AC-coupled and terminated.
- 3. Measured with a PRBS 2⁷-1 test pattern @1250Mbps, BER≤1x10⁻¹².
- 4. Internally AC-coupled.





Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock			400	KHz
MOD_DEF (0:2)-High	V _H	2		Vcc	V
MOD_DEF (0:2)-Low	V _L			0.8	V

Diagnostics Specification

Parameter	Range	Unit	Accuracy	Calibration	
Tomogratura	0 to +70	°C	±3°C	Internal / External	
Temperature	-40 to +85		±3 C		
Voltage	3.0 to 3.6	V	±3%	Internal / External	
Bias Current	0 to 100	mA	±10%	Internal / External	
TX Power	-9 to -3	dBm ±3dB Inte		Internal / External	
RX Power	-23 to -3	dBm	±3dB	Internal / External	

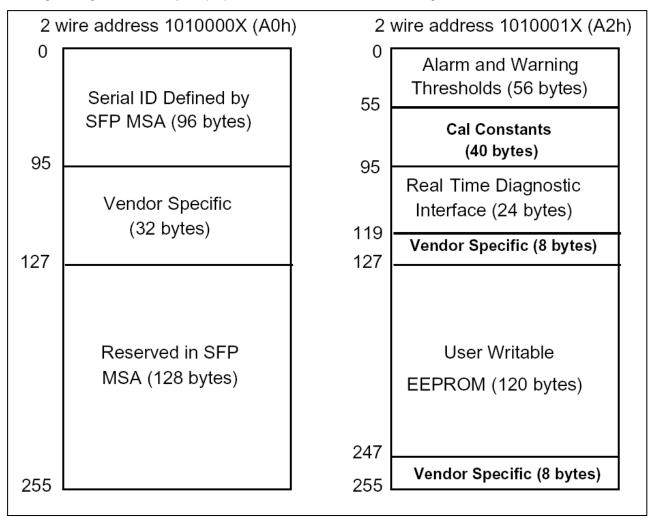


Digital Diagnostic Memory Map

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.





SFP Transceiver Electrical Pad Layout

20 [VeeT		1	VeeT
19 [TD-		2	TxFault
18 [TD+		3	Tx Disable
17 [VeeT		4	MOD-DEF(2)
16 [VccT		5	MOD-DEF(1)
15 [VccR		6	MOD-DEF(0)
14 [VeeR		7	Rate Select
13 [RD+		8	LOS
12 [RD-		9	VeeR
11 [VeeR		10	VeeR
	Top of Board Board (as viewed thru top of board)			



Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connect	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver ground	1	
10	VeeR	Receiver ground	1	
11	VeeR	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver ground	1	
15	VccR	Receiver Power Supply	2	
16	VccT	Transmitter Pow er Supply	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7k\sim10k\Omega$ resistor. Its states are:

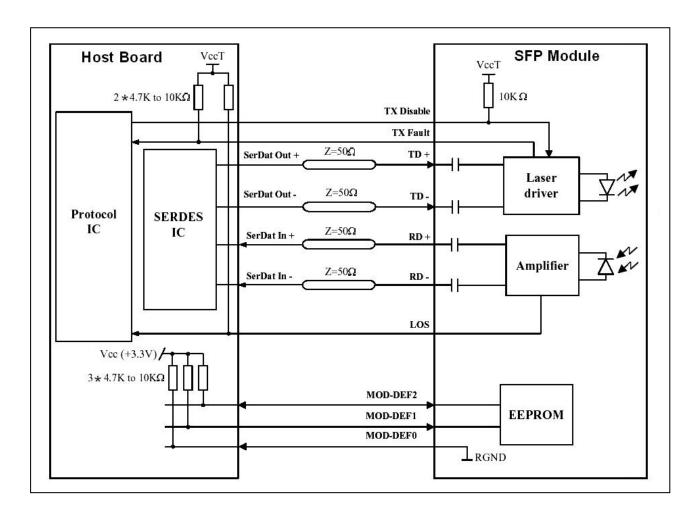
 $\begin{array}{ll} \mbox{Low (0 to 0.8V):} & \mbox{Transmitter on} \\ \mbox{(>0.8V, < 2.0V):} & \mbox{Undefined} \end{array}$

High (2.0 to 3.465V): Transmitter Disabled Open: Transmitter Disabled

- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccTor VccR
 - Mod-Def 0 is grounded by the module to indicate that the module is present
 - Mod-Def 1 is the clock line of two wire serial interface for serial ID
 - Mod-Def 2 is the data line of two wire serial interface for serial ID
- 4) LOS is an open collector output, which should be pulled up with a $4.7k\sim10k\Omega$ resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

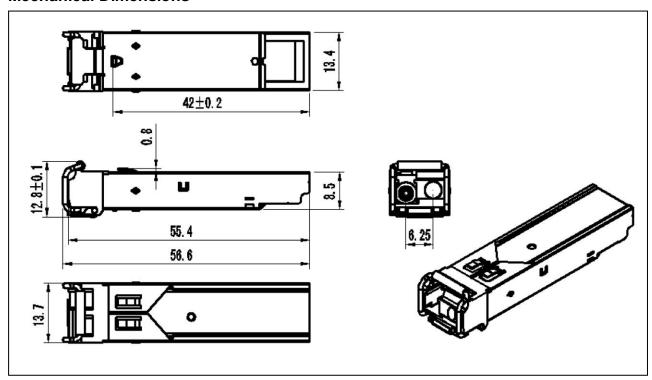


Recommended Interface Circuit





Mechanical Dimensions



Regulatory Compliance

Feature	Stand ard	Perform ance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1(>500 V) Isolation with the case
Electromagnetic Interference (EMI)	FCC Part 15 Class B	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN60950, EN (IEC) 60825-1,2	Compatible with Class I laser product. Compatible with TüV standards
Component Recognition	UL and CUL	UL file E317337
Green Products	een Products 2002/95/EC 2005/618/EC RoHS6	



Ordering information

Part Number	Product Description
TS-WDM-0220A	Tx1550/Rx1310nm, 1.25Gbps, LC, 20km, 0°C~+70°C
TS-WDM-0220DA	Tx1550/Rx1310nm, 1.25Gbps, LC, 20km, 0°C~+70°C, With Digital Diagnostic Monitoring
TS-WDM-0220IA	Tx1550/Rx1310nm, 1.25Gbps, LC, 20km, -40°C~+85°C
TS-WDM-0220DIA	Tx1550/Rx1310nm, 1.25Gbps, LC, 20km, -40°C~+85°C, With Digital Diagnostic Monitoring

References

- 1. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA), September 2000.
- 2. Telcordia GR-253-CORE and ITU-T G.957 Specifications.

Important Notice

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